

The ARM8

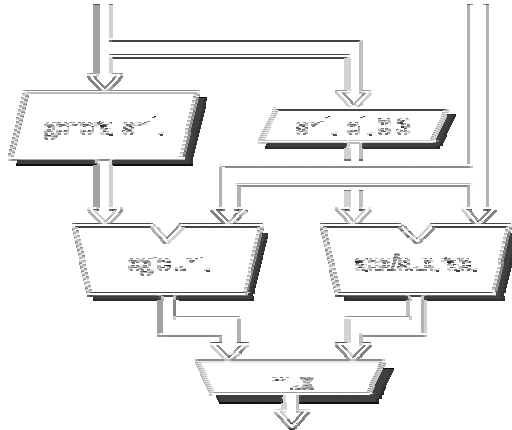
- ARM8 was designed for higher performance than ARM7 through:
 - an increased clock rate
 - simpler logic in each pipeline stage
 - a deeper pipeline
 - a reduced CPI (Clocks Per Instructions)
 - reducing the number of pipeline slots some instructions take
 - removing pipeline stalls

The ARM8 Pipeline

- ARM8 uses a 5-stage pipeline:
 - instruction fetch
 - performed by an autonomous prefetch unit
 - instruction decode and register read
 - execute (shift and ALU)
 - optimized to fit into a single pipeline stage
 - data memory access
 - write-back results

The ARM8 Pipeline (2)

- The optimized ALU/shifter arrangement
 - only carefully chosen shifts in series with adder



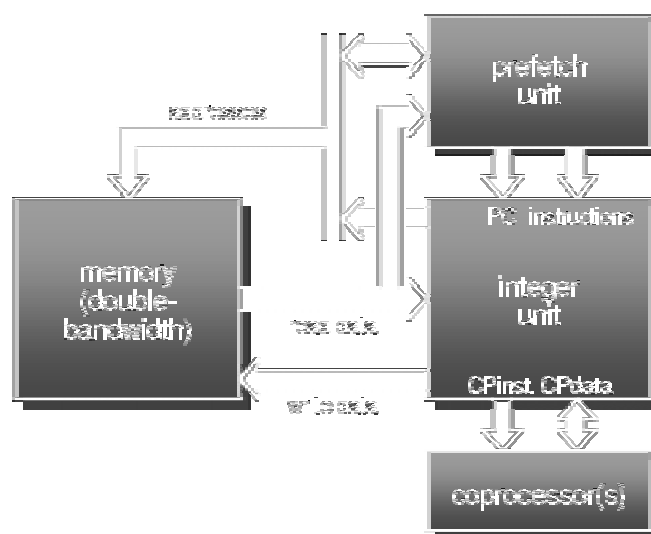
The ARM8 (2)

- Reducing the CPI
 - ARM7 uses the memory on nearly every clock cycle
 - for either instruction fetch or data transfer
 - therefore a reduced CPI requires more than one memory access per clock cycle
- Possible solutions are:
 - separate instruction and data memories
 - double-bandwidth memory

The ARM8 (3)

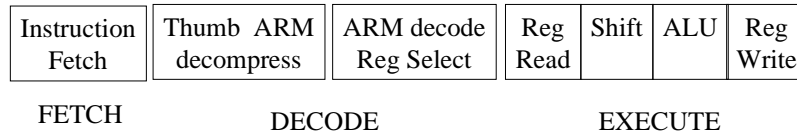
- Double-bandwidth memory
 - exploits the sequential nature of accesses
 - instruction fetches are mainly sequential
 - load and store multiples are sequential
 - each clock cycle allows a random access
 - the next sequential word is available half a cycle later
 - lower cost than, and equivalent performance to, a 64-bit memory

ARM8 Processor Core

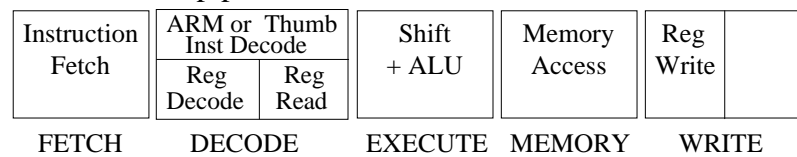


ARM9TDMI pipeline

- ARM7TDMI pipeline:



- ARM9TDMI pipeline:



- Thumb instructions are decoded directly

ARM9TDMI

- EmbeddedICE
 - as ARM7TDMI, plus:
 - hardware single-stepping
 - breakpoints on exceptions
- On-chip coprocessor support:
 - for floating-point, DSP, and so on

Process	0.35 μm	Transistors	111.000	MIPS	220
Metal layers	3	Die area	5 mm ²	Power	<800 mW
Vdd	3.3 V	Clock	0 to 200 MHz	MIPS/W	>280

ARM10

- Targets multi-media digital consumer applications
 - high-performance hand-held devices (organizers, smart phones)
 - set top boxes
 - sophisticated UI and 2D-/3D-graphics rendering
 - high performance printers
- Vector floating point Copro (VFP 10) delivering 600 MFLOPS
- Parallel instruction execution

ARM System Design

- History of ARM
- ARM Instruction Set
- Thumb Instruction Set
- ARM Cores
- ARM Cache Modeling
- ARM CPUs
- ARM Coprocessors

Cache Modeling

- Memory hierarchy
- Cache organization
- ARMulator
- Cache modeling using Cheetah

Memory hierarchy

- A typical system has several different memory subsystems:
 - processor registers: ~100 bytes, 2ns
 - access is a small part of a clock cycle
 - on-chip cache or RAM: ~10 Kbytes, 10ns
 - accessed at the processor clock rate
 - off-chip ROM and RAM : ~Mbytes, 100ns
 - access costs several processor cycles
 - backup store: ~ GBytes, 10ms

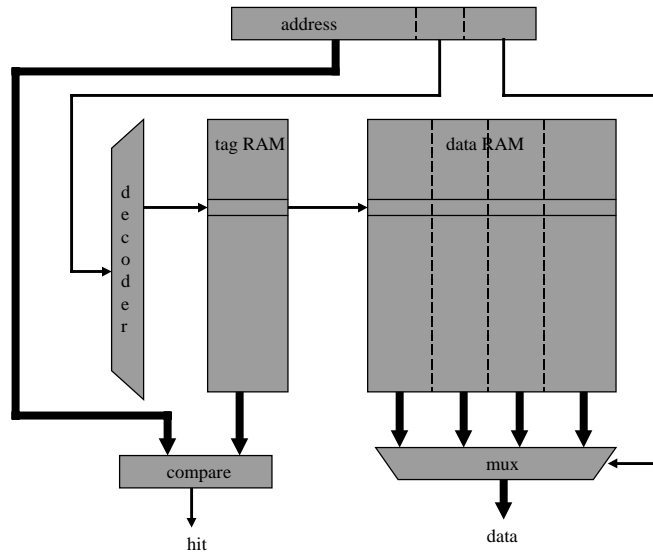
Memory hierarchy

- The objective is to approach:
 - the performance of the fastest memory...
 - ...at the cost/bit of the slowest memory
- Feasible because programs display:
 - *temporal locality*
 - accesses to a location are clustered in time
 - *spatial locality*
 - accesses are clustered in the address space

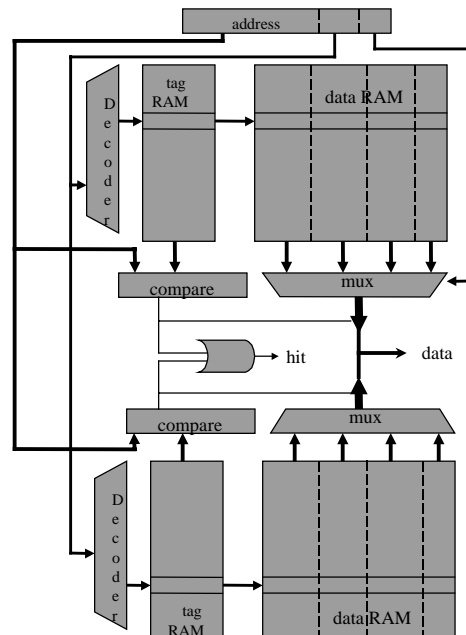
Cache organization

- There are many ways to arrange a cache:
 - separate or mixed instructions and data?
 - How much memory should be loaded on a cache *miss*?
 - How flexible should the allocation of cache space be?
 - How should writes be handled?

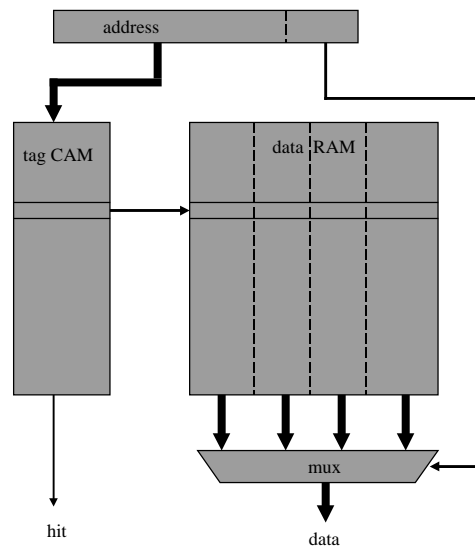
Direct-mapped cache organization



2-way set-associative cache organization



Fully associative cache organization



Cache write strategies

- Write-through
 - all data is written to memory; matching cache locations are updated
- Write-through with write buffer
 - all data is written to memory, but the write is performed through a buffer
- Write-back
 - the processor writes to the cache - main memory is only updated on flushes.

Cache organizational options

- There are many design decisions involved in choosing the best cache
 - some of the issues are summarized below:

Organizational feature	Options		
Cache-MMU relationship	Physical cache	Virtual cache	
Cache contents	Unified instruction and data cache	Separate instruction and data caches	
Associativity	Direct-mapped RAM-RAM	Set-associative RAM-RAM	Fully associative CAM-RAM
Replacement strategy	Cyclic	Random	LRU
Write strategy	Write-through	Write-through with write buffer	Write-back

Cache power-efficiency

- What is influence of organization on power-efficiency?
 - a high hit rate minimizes off-chip activity
 - hit rate increases with associativity (up to 4)
 - set-associative caches burn more power
 - due to the increased number of active sense amplifiers
 - CAM (in fully associative caches) is also power-hungry

Cache power-efficiency

- How can cache power-efficiency be improved?
 - use serial tag and data accesses in a set-associative cache
 - enable only the relevant data RAM
 - segment the CAM in a fully associative cache
 - discussed further in ARM600
 - exploit sequential address sequences

Sequential Access

- Accessing memory locations in same line:
bypass tag look-up
 - increases access speed
 - saves power
- ARM CPUs generate a signal, when next memory access is sequential
- using current address and sequential signal:
deduce that the access will fall in same line

Cache Speed

- High associativity caches: best hit rate
- Sequential CAM-RAM access: limits cycle time
- Lower associativity: parallel tag and data access
- Beyond 4-way associativity: gains in hit rate small
- However: Fast CAM-RAM cache is much simpler than
4-way associative RAM-RAM Cache

Power Optimization

- Minimize overall system power!
 - good hit rate necessary
- highly associative CAM-RAM or set-associative RAM-RAM:
 - strongly influenced by low-level circuit issues
- 75% of all access are sequential
- sequential access may reduce performance by 25%
and reduce cache power requirements by a factor of 2 or 3!

On-chip RAM

- System benefits of on-chip memory:
 - increased performance - no wait states
 - reduced power consumption
 - improved EMC
- On-chip RAM is used in preference to a cache in some embedded systems:
 - it is simpler, cheaper and uses less power
 - its behavior is more deterministic
 - however it requires explicit management

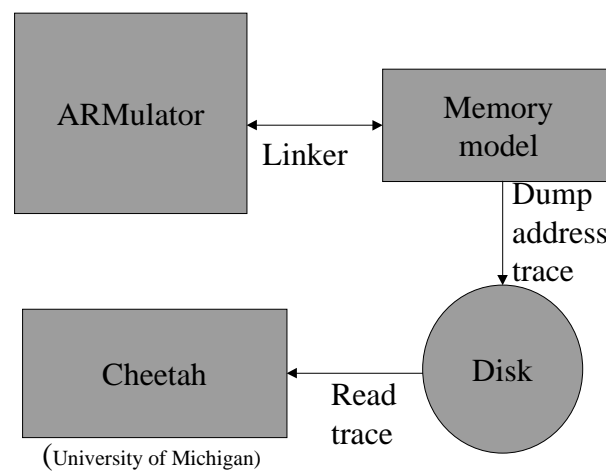
ARMulator

- Emulates ARM processor cores
- Can be extended to model nearly any ARM based system
- Three levels of accuracy:
 - instruction accurate
 - cycle-accurate
 - timing-accurate
- Initial evaluation of design alternatives:
 - instruction accurate model

Instruction Accurate Model

- Model of ARM processor:
not customizable, handles communication with debugger
- Memory interface:
fully customizable memory model
- Coprocessor interface
- Operating system interface

Cache Evaluation



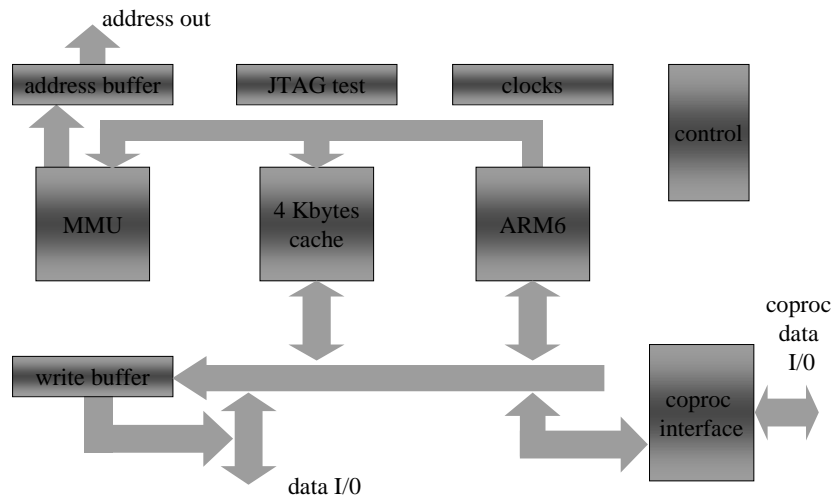
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ARM600

- General features:
 - ARM6 processor core
 - 4 Kbytes 64-way associative cache
 - mixed instruction and data
 - write-through with buffered write
 - MMU
 - support for on- and off-chip coprocessors
 - JTAG test access port

The ARM600 organization



ARM600 cache design

- The ARM600 cache was based on the ARM3 design, where:
 - extensive simulations were performed to evaluate organizational options
 - models were incrementally refined to approach 'real' memory timings
 - start from 'perfect' cache
 - this gives an upper bound on performance

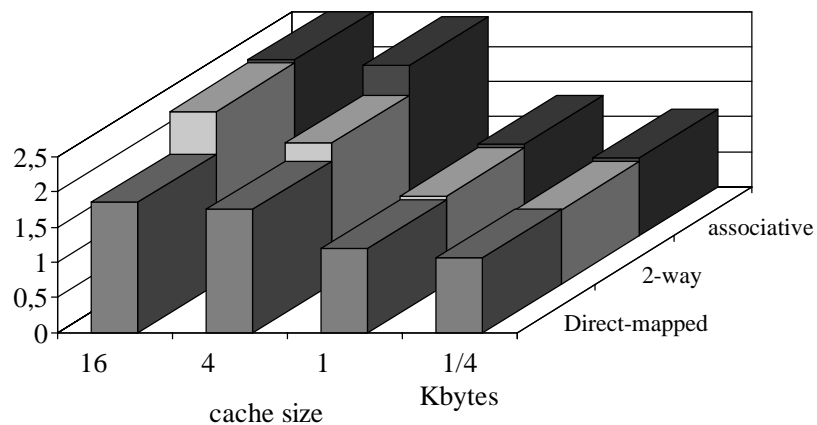
`Perfect` cache performance

<u>Cache form</u>	<u>Performance</u>
No cache	1
Instruction-only cache	1.95
Instruction and data cache	2.5
Data-only cache	1.13
<ul style="list-style-type: none">• assuming realistic clock rates<ul style="list-style-type: none">– 20 MHz cache operation– 8 MHz external memory• mixed cache gives best performance<ul style="list-style-type: none">– separate I/D cache not on option with ARM6	

Cache organization

- Write-through chosen for simplicity
 - allocate on write miss gave negligible benefits for significant complexity
- Look at size and associativity
 - maximum realistic size was 4 Kbytes
 - 1990 technology!
 - around this size associativity has strong effect on hit rate

Unified cache performance as a function of size and organization



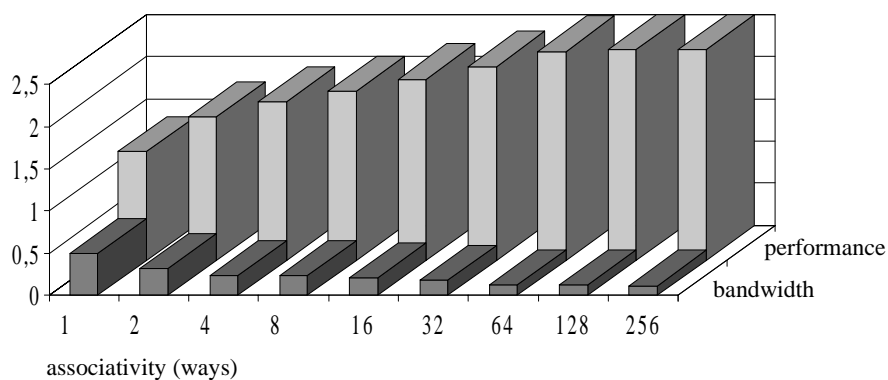
Cache Organization

- So, high associativity is desirable
- Replacement algorithm?
 - LRU (Least Recent Used) is deal
 - but expensive to implement
 - cyclic replacement is simple
 - but has obvious pathological cases
 - random performance as well as LRU
 - and is simple to implement

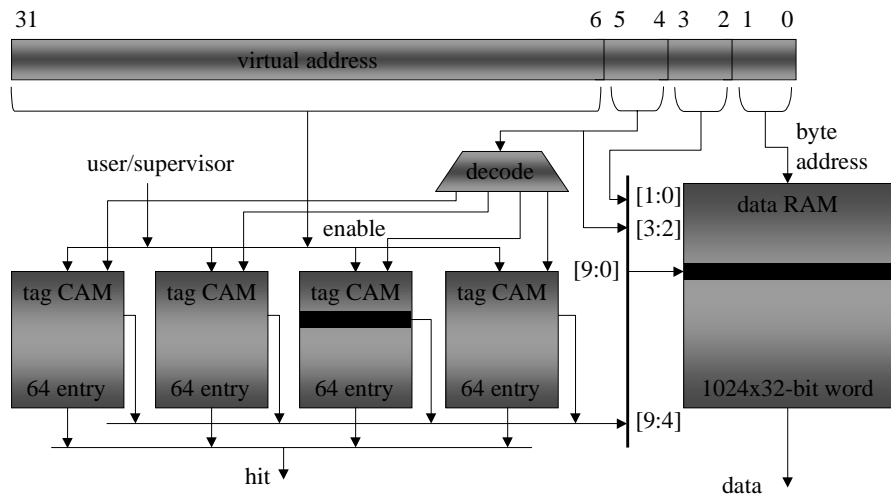
Cache organization

- Full associativity?
 - Very large CAMs consume too much power
 - line size
 - a quad-word line size:
 - reduces the size of the tag store (by 4x)
 - has negligible impact on performance
 - slightly reduced associativity
 - has little effect on performance
 - allows the CAM to be segmented
 - » only active segment uses power

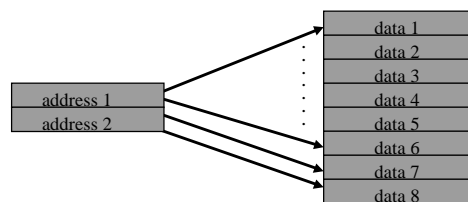
The effect of associativity on performance and bandwidth



ARM600 cache organization



ARM600 write buffer



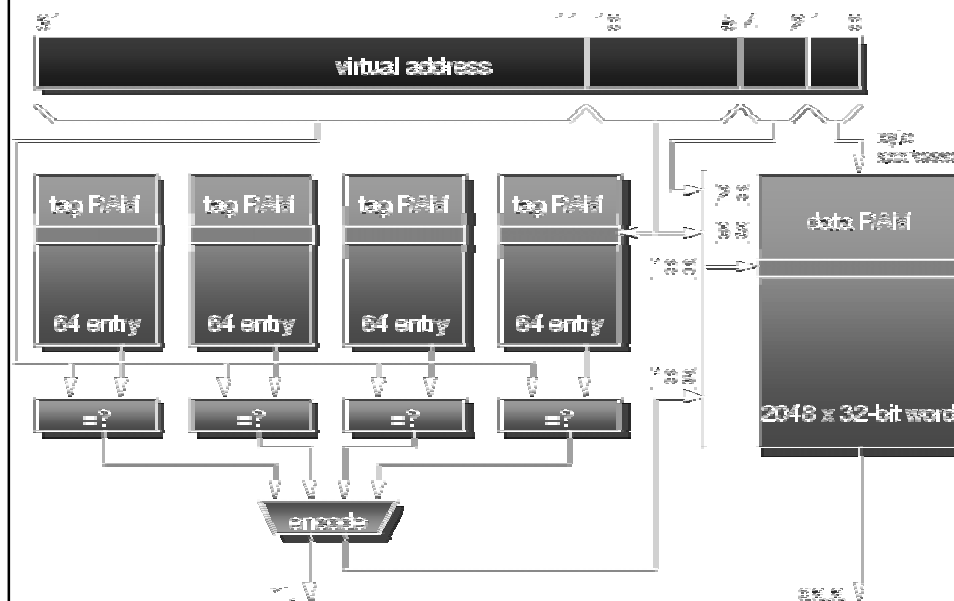
- 2 address, 8 data locations
 - flexible association from address to data
 - only STM can generate multiple data items for one address

The ARM610

- The ARM610 is an ARM600
 - without external coprocessor support
 - in a 144-pin TQFP `thin quad flat pack`
 - as used in the original Apple Newton
 - original on 1 μm CMOS, now on 0.6 μm

Process	0.6 μm	Transistors	358,931	MIPS	30
Metal layers	2	Die area	26 mm^2	Power	500 mW
Vdd	5 V	Clock	0 to 33 MHz	MIPS/W	60

The ARM700 Cache Organization



The ARM700 and 710

- Differences from the 600 and 610
 - ARM7 core
 - operates at 3v3 as well as 5v
- cache is 8 Kbytes, 4-way, 8-word line
 - later ARM710s have reverted to a 4-word line
- TLB has 64 entries instead of 32
- write buffer has 4 address, 8 data slots
- clock rate increased
 - from 33 MHz to 40 MHz at 5v

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Design and Application of Cores

- Microprocessor Cores (ARM)
- On-chip buses

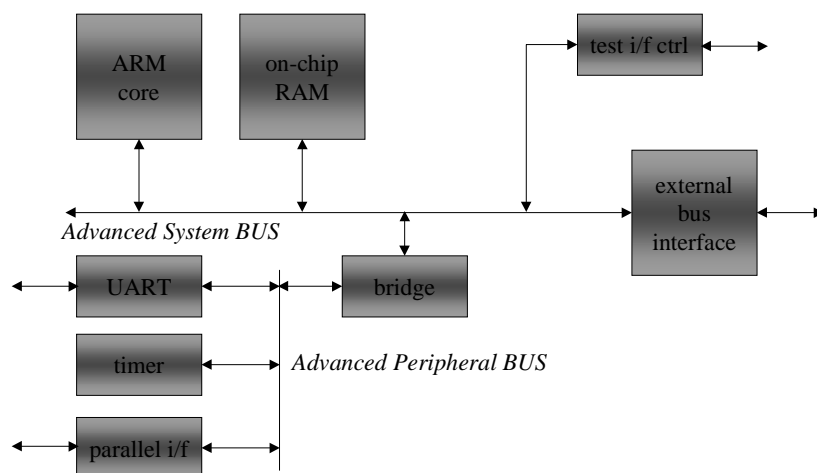
ARM Coprocessors

- Details see ARM6 organization
- No tremendous changes

AMBA

- Advanced Microprocessor Bus Architecture
 - a systematic solution to assembling macrocell-based systems
- AMBA structure:
- Advanced System Bus (ASB)
 - high-performance, multi-master
- Advanced Peripheral Bus (APB)
- interface for low performance peripherals

A typical AMBA-based system



AMBA test interface

- VSLI production test is an economically important issue
 - macrocell based designs present problems
 - how can each macrocell be systematically tested?
- AMBA offers a standardized solution
 - based on 32-bit parallel access, via the bus, to test registers